

MOLD-TEK
Packaging Limited
(Formerly known as Moldtek Plastics Ltd.)

21st September, 2020

To, BSE Limited., 1 st Floor, New Trading Wing, Rotunda Building, P.J. Towers, Dalal Street, Fort, Mumbai – 400 001 BSE Scrip code: 533080	To, National Stock Exchange of India Ltd., Exchange Plaza, 5 th Floor, Plot No. C/1, G Block, Bandra-Kurla Complex, Bandra (E), Mumbai – 400 051 Ref: MOLDTKPAC - EQ
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Dear Sir / Madam,

Subject: Regulation 30 of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015:

Further to our intimation dated September 16, 2020 and pursuant to Regulation 30 of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, as amended, we wish to inform you that the board of directors of the Company (“**Board**”), at its meeting held today, i.e., September 21, 2020 considered and approved, amongst others, the issuance of equity shares (fully paid-up or partly paid-up), share warrants, other eligible securities, convertible securities or a combination of the any of the aforementioned securities of the Company as is permitted under the Securities and Exchange Board (Issue of Capital and Disclosure Requirements) Regulations, 2018 as amended (“**SEBI ICDR Regulations**”), on rights basis to eligible shareholders of the Company as on the record date (to be decided subsequently) for an aggregate amount not exceeding **Rs. 90 crores (Rs. Ninety Crores only)** (the “**Issue**”) in accordance with the provision of the Companies Act, 2013 and Securities and Exchange Board of India (Issue of Capital and Disclosure Requirements) Regulations, 2018 accordance with the provisions of the Memorandum of Association and the Articles of Association of the Company, SEBI ICDR Regulations, the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, the listing agreement executed with the Stock Exchanges, the Securities Contracts (Regulation) Act, 1956, the Securities Contracts (Regulation) Rules, 1957, the Consolidated FDI Policy of 2017 and the Foreign Exchange Management Act, 1999 and rules and regulations made thereunder, including the Foreign Exchange Management (Non-debt Instruments) Rules, 2019, each as amended. Further the final issue size/amount shall be decided by the “Committee of Directors.” (Rights Issue)

Further, the Board appointed Emkay Global Financial Services Limited as the lead manager to the Issue and constituted a Committee of Directors (Rights Issue) to decide the other terms and conditions of the Issue including the record date.

The meeting of the Board commenced at 11.30 a.m and concluded at 12:20 p.m.

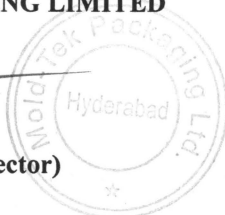
We request you to take this on record, and to treat the same as compliance with the applicable provisions of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, as amended.

Thanking you,

Yours truly,

For MOLD-TEK PACKAGING LIMITED


J Lakshmana Rao
(Chairman & Managing Director)



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